

# Accelerate Your Trading Strategies: Introducing the New Alveo™ X3 Series

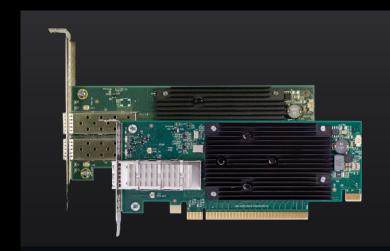
Hamid Salehi, Director of Product Marketing, Fintech and Blockchain AECG Group, AMD

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## Introducing the Alveo™ X3 Series Adapters

In Production

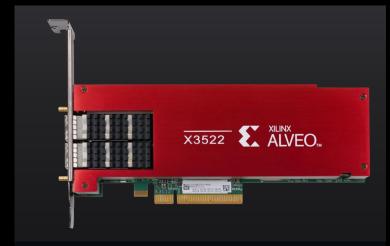


#### **X2 Series**

Offload NICs

- X2522 Low Latency NIC 2x10/25G
- X2541 Low Latency NIC 1x 10/25/40/50/100G

**Alveo X3 Series** 



#### Alveo X3522

Low Latency Network Adapter

- 4x10/25G
- Lower latency
- Improved architecture
- Upgradeable
- Optional upgrade access to 400K LUTs



#### Alveo X3522PV

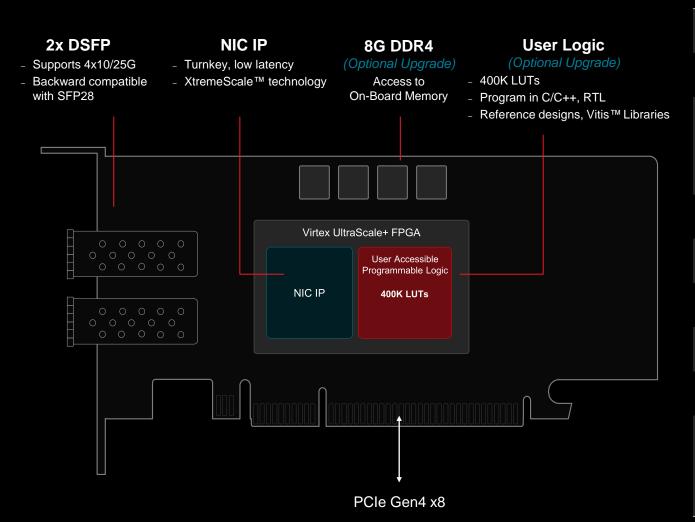
Accelerator Card

- 2x DSFP connectors
- Time synchronization (PPS In/Out)
- Access to ~1M LUTs
- -3 silicon enables up to 644MHz operation, 16b



## **Low Latency NIC Features and Capabilities**

*Alveo™ X3522* 

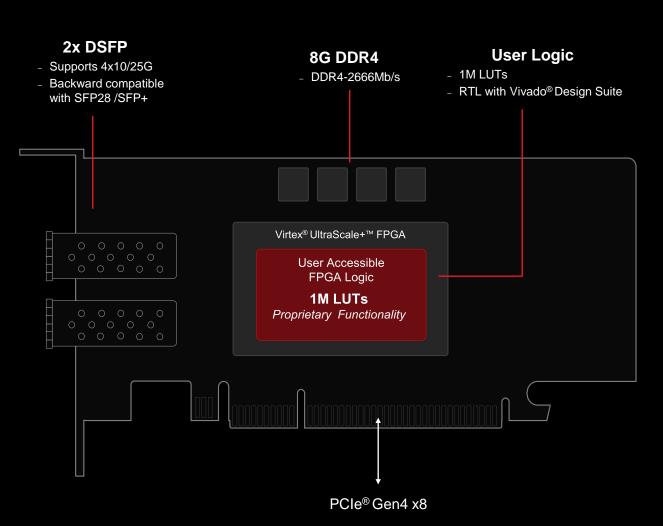


FEATURES	SPECIFICATION
Power	<ul><li> 35W (NIC mode)</li><li> Up 75W max power (hybrid mode) (PL dependent)</li></ul>
User Functional Space	400K LUTs (hybrid upgrade package)
Programmability	<ul> <li>C/C++ High-Level Synchess (HLS)</li> <li>RTL (hardware design)</li> <li>ULL Framework IP from Orthogone Technologies</li> <li>ANTS reference design (utilizes Onload®)</li> <li>Delegated Send</li> </ul>
Memory	8GB DDR4 (hybrid upgrade package)
PCIe <sup>®</sup> Config	Gen4 x8
Network Port Config	4 x 10GbE/25GbE
1PPS Support	SMA connector, through IO bracket
PTP	Stratum 3 oscillator, PTPv2 support
Software	<ul> <li>Vitis® SW Environment (C/C++, libraries)</li> <li>Onload SW for kernel bypass</li> <li>TCPDirect</li> <li>ef_vi API for latency optimization</li> <li>XRT runtime SW</li> </ul>



## **Accelerator Card Features and Capabilities**

## Alveo™ X3522PV



FEATURES	SPECIFICATION
Power	75W Max Power
Device	<ul><li>Virtex UltraScale+ XCUX35</li><li>-3 speed grade</li></ul>
SerDes (GTY) Capability	16b, 644MHz operation supported
Programmability	Vivado Design Suite
Memory	8GB DDR4
PCIe Config	Gen4 x8
Network Port Config	4 x 10GbE/25GbE
1PPS Support	SMA connector, through IO bracket
Software	Vivado Design Suite
Sideband Support	PLDM over MCTP over SMBus
LUTs	1,030K
Embedded RAM	<ul><li>99 Mb UltraRAM</li><li>74.3Mb Block RAM</li></ul>



## **Alveo™ X3 Series Advantages**



#### Low latency, plug-and-play NIC

High port density (4x 10/25GbE), based on Xtremescale™ NIC technology



#### **Determinism for reliable trade execution**

Reordering, underruns, collisions handled by NIC



#### **CPU offload for hybrid trading**

Offload business logic to NIC



#### **HW** upgradeable after deployment

Integrate new features from AMD



#### **Adaptable Acceleration and Customization**

Hardware flexibility for custom fintech solutions

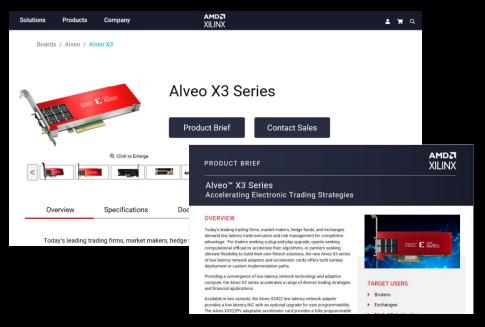


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